INTEGRATED CIRCUITS

DATA SHEET

74F14Hex inverter Schmitt trigger

Product specification

1990 Nov 26

IC15 Data Handbook





74F14

FEATURE

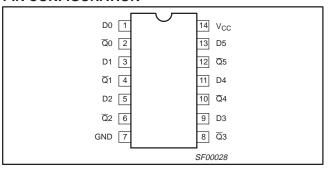
• Industrial temperature range available (-40°C to +85°C)

TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F14	5.0ns	18mA

DESCRIPTION

The 74F14 contains six logic inverters which accept standard TTL input signals and provide standard TTL output levels. They are capable of transforming slowly changing input signals into sharply defined, jitter free output signals. In addition, they have greater noise margin than conventional inverters. Each circuit contains a Schmitt trigger followed by a Darlington level shifter and a phase splitter driving a TTL totem-pole output. The Schmitt trigger uses positive feedback to effectively speed-up slow input transitions, and provide different input threshold voltages for positive-going and negative-going input threshold (typically 800mV) is determined internally by resistor ratios and is insensitive to temperature and supply voltage variations.

PIN CONFIGURATION



ORDERING INFORMATION

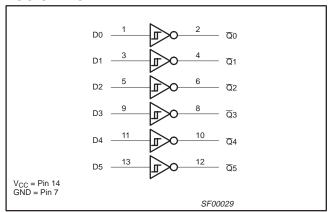
	ORDER CODE							
DESCRIPTION	COMMERCIAL RANGE $V_{CC} = 5V \pm 10\%$, $T_{amb} = 0$ °C to +70°C	INDUSTRIAL RANGE V_{CC} = 5V ±10%, T_{amb} = -40°C to +85°C	PKG DWG #					
14-pin plastic DIP	N74F14N	I74F14N	SOT27-1					
14-pin plastic SO	N74F14D	I74F14D	SOT108-1					

INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
Dn	Data inputs	1.0/1.0	20μA/0.6mA
Qn	Data output	50/33	1.0mA/20mA

NOTE:

LOGIC DIAGRAM



FUNCTION TABLE

INPUTS	OUTPUT
Dn	Qn
L	Н
Н	L

NOTES:

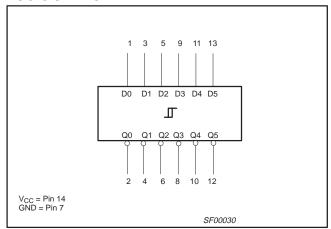
H = High voltage level

L = Low voltage level

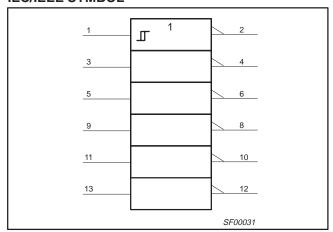
¹ One (1.0) FAST unit load is defined as: $20\mu A$ in the High state and 0.6mA in the Low state.

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LOGIC SYMBOL



IEC/IEEE SYMBOL



ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free-air temperature range.)

SYMBOL	PARAMETER		RATING	UNIT
V _{CC}	Supply voltage		-0.5 to +7.0	V
V _{IN}	Input voltage		-0.5 to +7.0	V
I _{IN}	Input current		−30 to +5	mA
V _{OUT}	Voltage applied to output in high output state		−0.5 to V _{CC}	V
I _{OUT}	Current applied to output in low output state		40	mA
_		Commercial range	0 to +70	°C
T _{amb}	Operating free-air temperature range	-40 to +85	°C	
T _{stg}	Storage temperature range	-	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER			LIMITS		UNIT
			MIN	NOM	MAX	
V _{CC}	Supply voltage		4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V	
V _{IL}	Low-level input voltage			0.8	V	
I _{lk}	Input clamp current				-18	mA
Гон	High-level output current				-1	mA
I _{OL}	Low-level output current				20	mA
-		Commercial range	0		+70	°C
T _{amb}	Operating free air temperature range	Industrial range	-40		+85	°C

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DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIO	NS ¹		LIMITS		UNIT
					MIN	TYP ²	MAX	
V _{T+}	Positive-going threshold		V _{CC} = 5.0V		1.4	1.7	2.0	V
V _T	Negative-going threshold	Negative-going threshold			0.7	0.9	1.1	V
ΔV_{T}	Hysteresis (V _{T+} – V _{T-})		V _{CC} = 5.0V		0.4	0.8		V
V _{OH}	High-level output voltage	$V_{CC} = MIN, V_I = V_{T-MIN},$	±10%V _{CC}	2.5			V	
			I _{OH} = MAX	±5%V _{CC}	2.7	3.4		V
V _{OL}	Low-level output voltage	ow-level output voltage		±10%V _{CC}		0.30	0.50	V
		$I_{OL} = MAX$		0.30	0.50	V		
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$		-0.73	-1.2	V	
I _{T+}	Input current at positive-going thre	shold	$V_{CC} = 5.0V, V_I = V_{T+}$		0		μΑ	
I _T _	Input current at negative-going thr	eshold	$V_{CC} = 5.0V, V_I = V_{T-}$		-175		μΑ	
II	Input current at maximum input vo	ltage	$V_{CC} = MAX, V_I = 7.0V$				100	μΑ
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$				20	μΑ
I _{IL}	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$				-0.6	mA
Ios	Short-circuit output current ³		V _{CC} = MAX		-60		-150	mA
I _{CC}	Supply current (total)	I _{CCH}	V _{CC} = MAX	V _{IN} = GND		13	22	mA
		I _{CCL}	$V_{CC} = MAX$	$V_{IN} = 4.5V$		23	32	mA

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

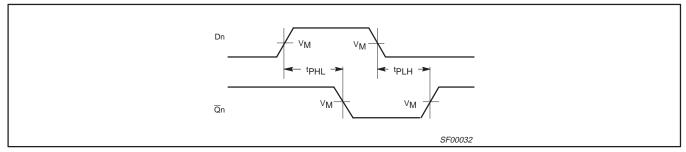
AC ELECTRICAL CHARACTERISTICS

				LIMITS							
SYMBOL PARAMETER		TEST CONDITION	V_{CC} = +5.0V T_{amb} = +25°C C_L = 50pF, R_L = 500 Ω			T _{amb} = 0°0	0V ± 10% C to +70°C R _L = 500Ω	$V_{CC} = +5.$ $T_{amb} = -40^{\circ}$ $C_{L} = 50pF$	UNIT		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX		
t _{PLH} t _{PHL}	Propagation delay Dn to Qn	Waveform 1	4.0 3.5	6.5 5.0	8.5 6.5	4.0 3.5	9.5 7.0	3.0 3.5	10.5 9.0	ns	

All typical values are at $V_{CC} = 5V$, $T_{amb} = 25^{\circ}C$. Not more than one output should be shorted at a time. For testing I_{OS} , the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

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AC WAVEFORMS

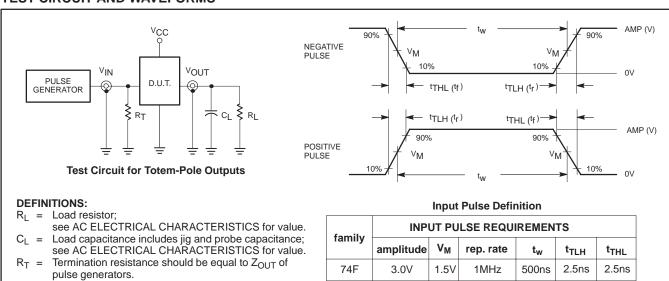


Waveform 1. Propagation delay for inverting outputs

NOTE:

For all waveforms, $V_M = 1.5V$.

TEST CIRCUIT AND WAVEFORMS

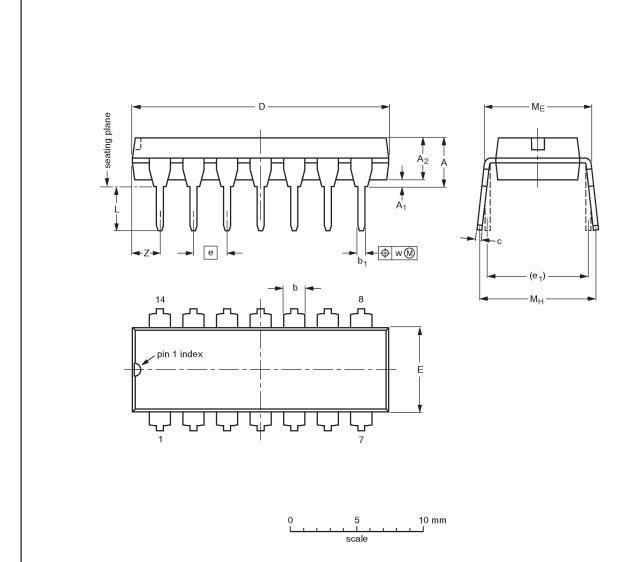


SF00006

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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE				
VERSION	IEC	IEC JEDEC EIAJ				ISSUE DATE	
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11	

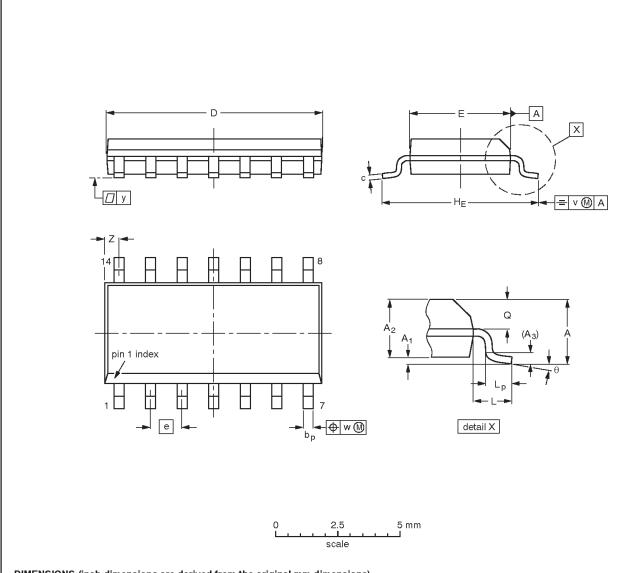
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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT108-1	076E06S	MS-012AB			-95-01-23- 97-05-22	

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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